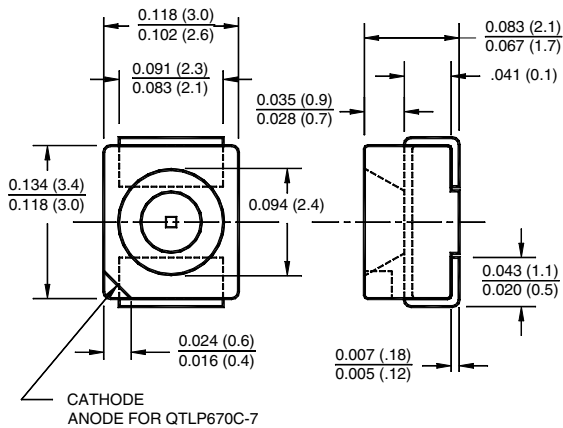


PACKAGE DIMENSIONS



NOTE:

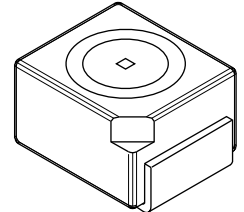
1. Dimensions for all drawings are in inches (mm).
2. QTLP670C-7 corner notch denotes anode.
3. QTLP670C-2,3,4,9 corner notch denotes cathode.

HER
YELLOW
GREEN
AlGaAs RED

QTLP670C-2
QTLP670C-3
QTLP670C-4
QTLP670C-7,9

FEATURES

- Non-diffused package excellent for back-lighting and coupling to light pipe
- Low package profile
- Low power dissipation
- Wide viewing angle of 120°



DESCRIPTION

This surface mount lamp is designed with a flat top and sides for automatic placement equipment. It is compatible with convective IR and vapor phase reflow soldering and conductive epoxy attachment process. The package size and configuration conform to EIA-535 BAAC standard specification for case size 3528 tantalum capacitor.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)

Parameter	HER QTLP670C-2	Yellow QTLP670C-3	Green QTLP670C-4	AlGaAs Red QTLP670C-7,9	Units
Continuous Forward Current - I _F	30	20	30	30	mA
Peak Forward Current - I _F (f = 1.0 KHz, Duty Factor = 1/10)	160	160	160	160	mA
Reverse Voltage - V _R (I _R = 10 μA)	5	5	5	5	V
Power Dissipation - P _D	100	85	100	100	mW
Operating Temperature - T _{OPR}	-40 to +100				°C
Storage Temperature - T _{STG}	-40 to +100				°C
Lead Soldering Time - T _{SOL}					
Wave	260 for 5 sec				°C
Reflow	260 for 10 sec				

ELECTRICAL / OPTICAL CHARACTERISTICS (T_A = 25°C)

Part Number	HER QTLP670C-2	Yellow QTLP670C-3	Green QTLP670C-4	AlGaAs Red QTLP670C-7,9	Condition
Luminous Intensity (mcd)					I _F = 20mA
Minimum	6	6	15	25	
Typical	10	10	25	40	
Forward Voltage (V)					I _F = 20mA
Maximum	2.8	2.8	2.8	2.4	
Typical	2.0	2.0	2.1	1.9	
Peak Wavelength (nm)	635	585	565	660	I _F = 20mA
Spectral Line Half Width (nm)	45	35	30	20	I _F = 20mA
Viewing Angle (°)	120	120	120	120	I _F = 20mA

HER
YELLOW
GREEN
AlGaAs RED

QTLP670C-2
QTLP670C-3
QTLP670C-4
QTLP670C-7,9

TYPICAL PERFORMANCE CURVES

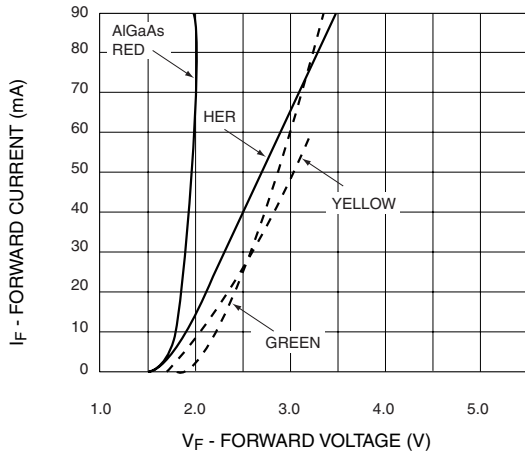


Fig. 1 Forward Current vs. Forward Voltage

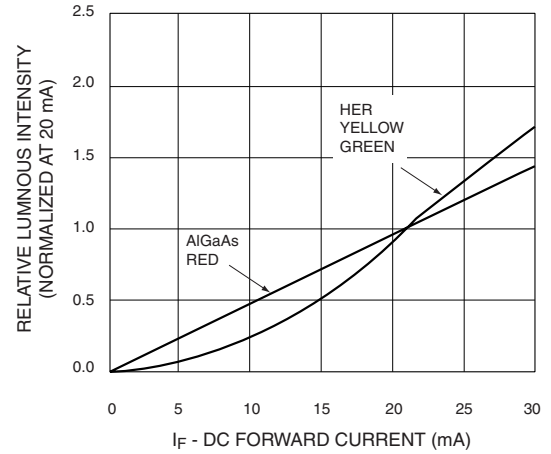


Fig. 2 Relative Luminous Intensity vs. DC Forward Current

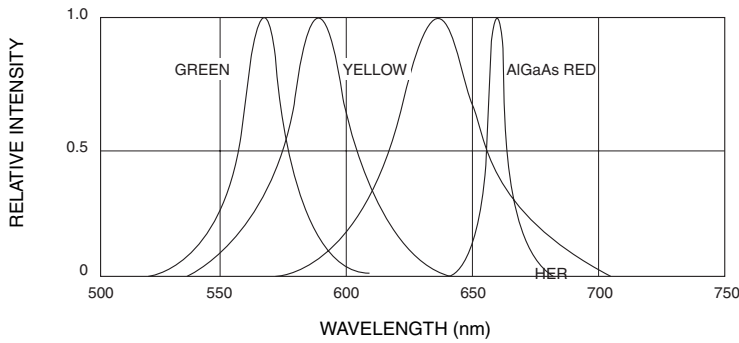


Fig. 3 Relative Intensity vs. Peak Wavelength

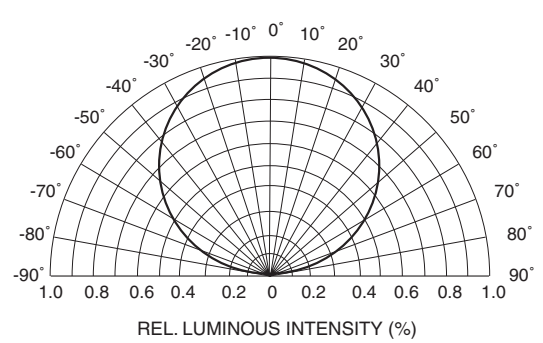


Fig. 4 Radiation Diagram

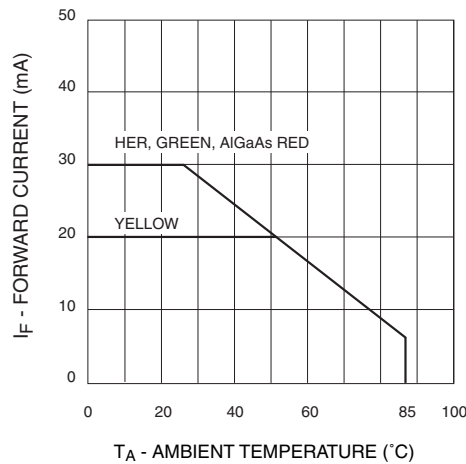
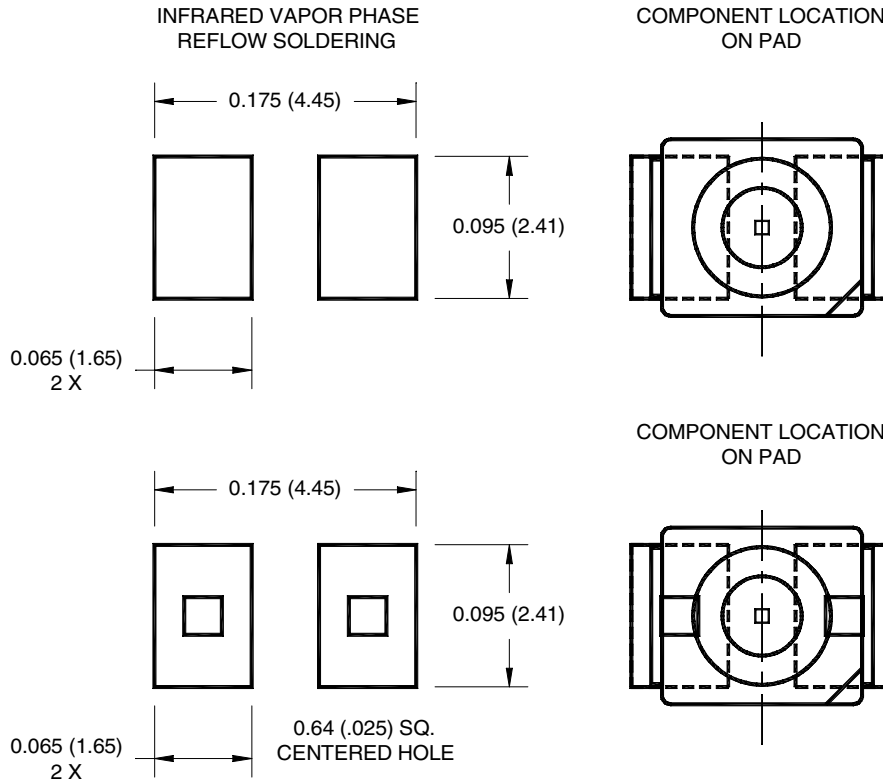


Fig. 5 Current Derating Curve

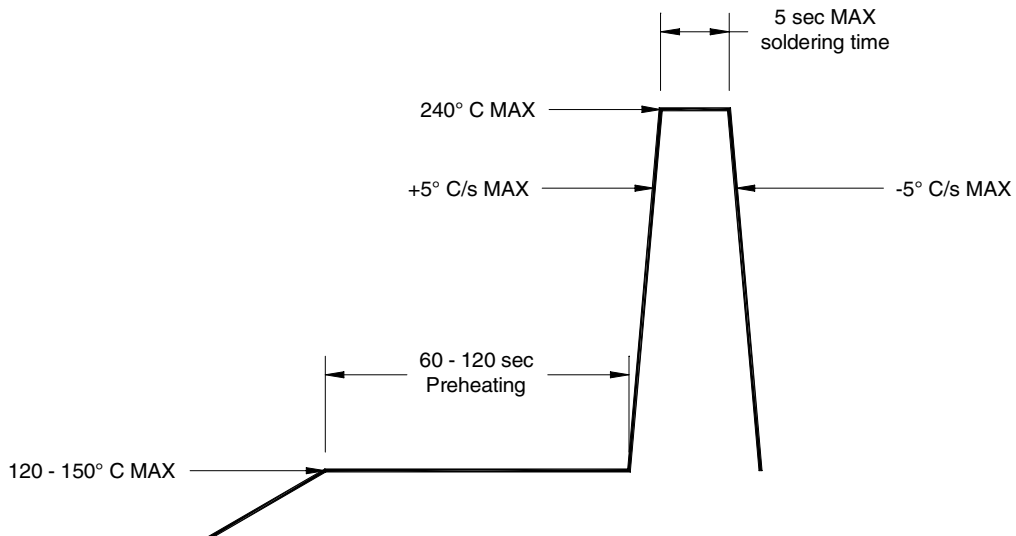
HER
YELLOW
GREEN
AlGaAs RED

QTLP670C-2
QTLP670C-3
QTLP670C-4
QTLP670C-7,9

RECOMMENDED PRINTED CIRCUIT BOARD PATTERN



RECOMMENDED IR REFLOW SOLDERING PROFILE



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